



30BQ150 SCHOTTKY RECTIFIER

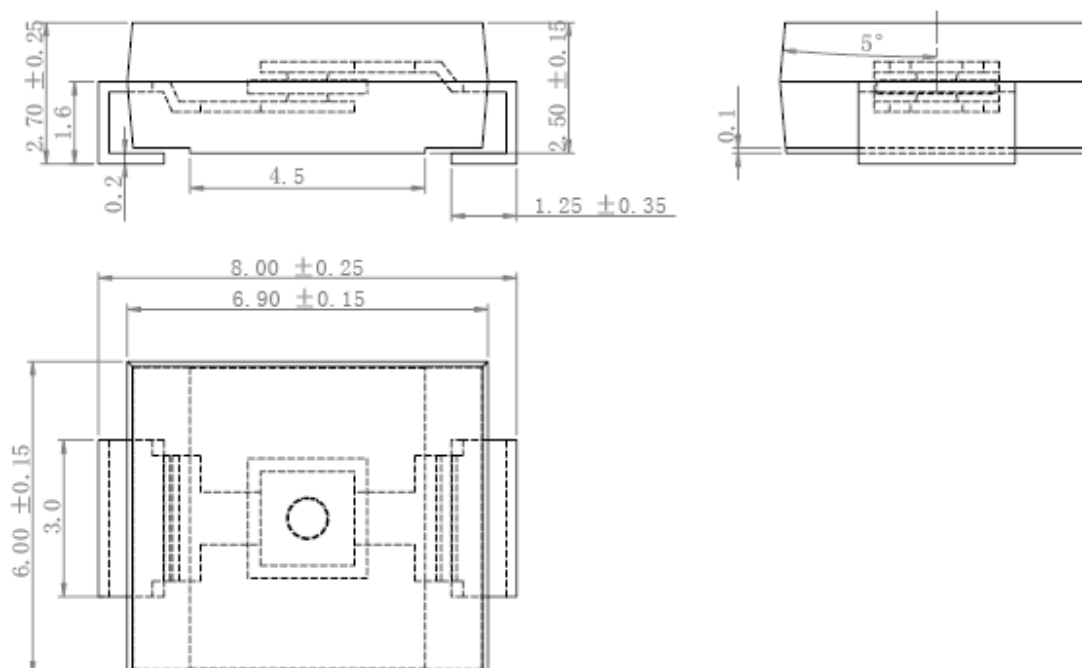
Applications:

- Disk Drives
- Switching power supply
- Redundant power subsystems
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery Charging

Features:

- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Dimensions (In mm / Inches):



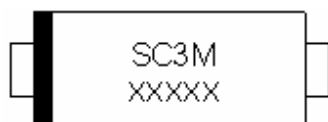
SMC



Technical Data
Data Sheet N0677, Rev. -

Green Products

Marking Diagram:



Where XXXXX is YYWWL

SC3M = Part Name
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
30BQ150	SMC (Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	150	V
Max. Average Forward Current	$I_{F(AV)}$	50% duty cycle @ $T_C=148^{\circ}C$, rectangular wave form	3.0	A
Max. Peak One Cycle Non-Repetitive Surge Current	I_{FSM}	8.3 ms, half Sine pulse	55	A



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Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop*	V_{F1}	@ 3 A, Pulse, $T_J = 25\text{ }^{\circ}\text{C}$	0.86	V
	V_{F2}	@ 3 A, Pulse, $T_J = 125\text{ }^{\circ}\text{C}$	0.70	V
Max. Reverse Current *	I_{R1}	@ $V_R = \text{Rated } V_R$, Pulse, $T_J = 25\text{ }^{\circ}\text{C}$	1	mA
	I_{R2}	@ $V_R = \text{Rated } V_R$, Pulse, $T_J = 125\text{ }^{\circ}\text{C}$	3	mA
Max. Junction Capacitance	C_T	@ $V_R = 5\text{ V}$, $T_C = 25\text{ }^{\circ}\text{C}$ $f_{\text{SIG}} = 1\text{ MHz}$	110	PF
Typical Series Inductance	L_S	Measured lead to lead 5 mm from package body	3.0	nH
Max. Voltage Rate of Change	dv/dt	-	10,000	V/ μs

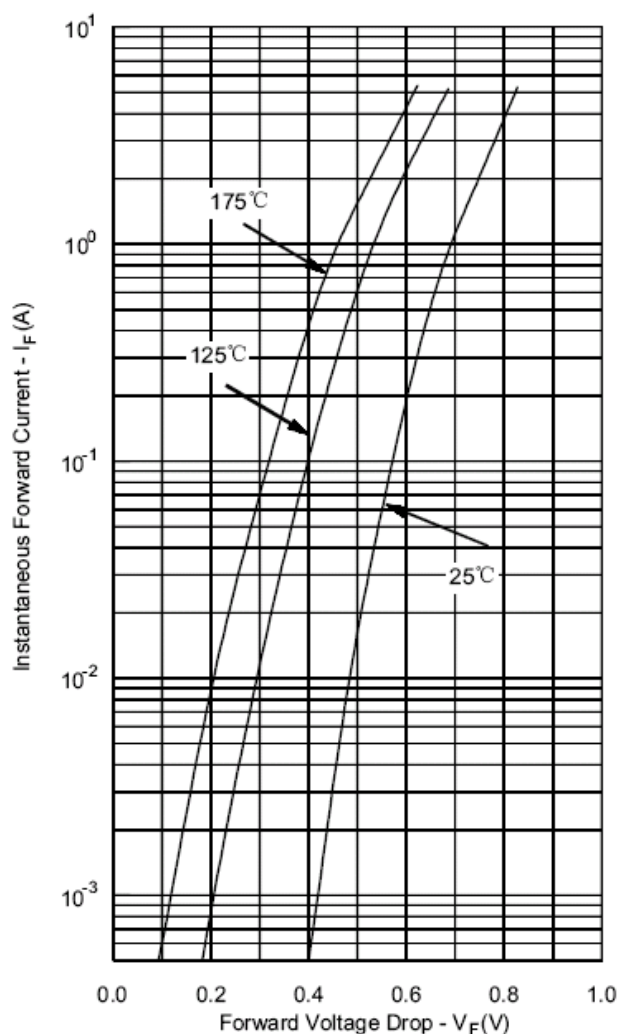
* Pulse Width < 300 μs , Duty Cycle < 2%

Thermal-Mechanical Specifications:

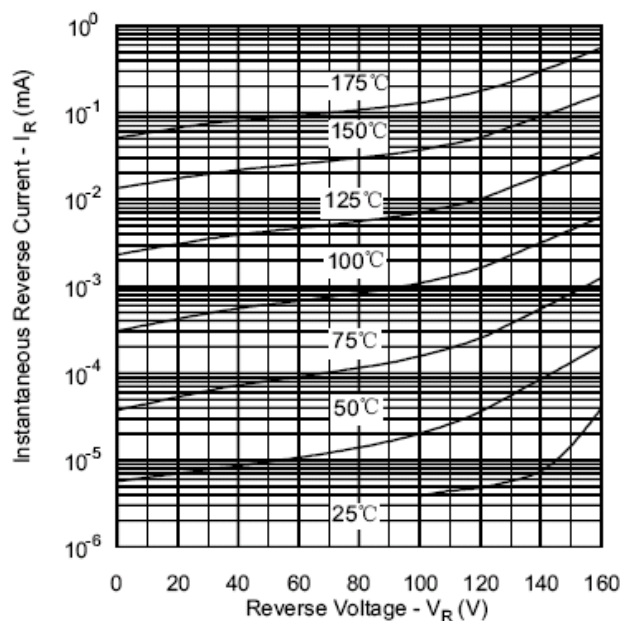
Characteristics	Symbol	Condition	Specification	Units
Max. Junction Temperature	T_J	-	-55 to +175	$^{\circ}\text{C}$
Max. Storage Temperature	T_{stg}	-	-55 to +175	$^{\circ}\text{C}$
Maximum Thermal Resistance Junction to Lead	$R_{\theta\text{JL}}$	DC operation	12	$^{\circ}\text{C/W}$
Maximum Thermal Resistance Junction to Case	$R_{\theta\text{JA}}$	DC operation	46	$^{\circ}\text{C/W}$
Approximate Weight	wt	-	0.65	g
Case Style	SMC			



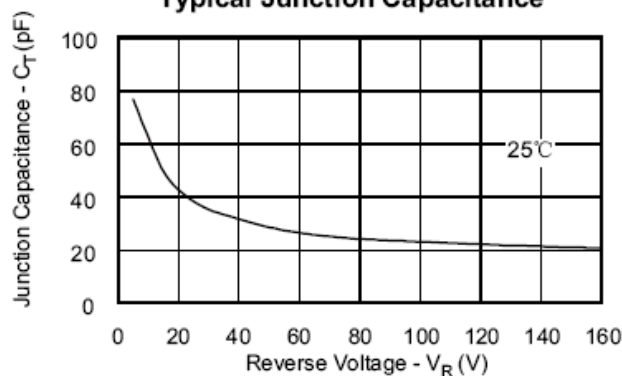
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance





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